

- IATF 16949 Production Line Certified
- Reliability Testing per AEC-Q200

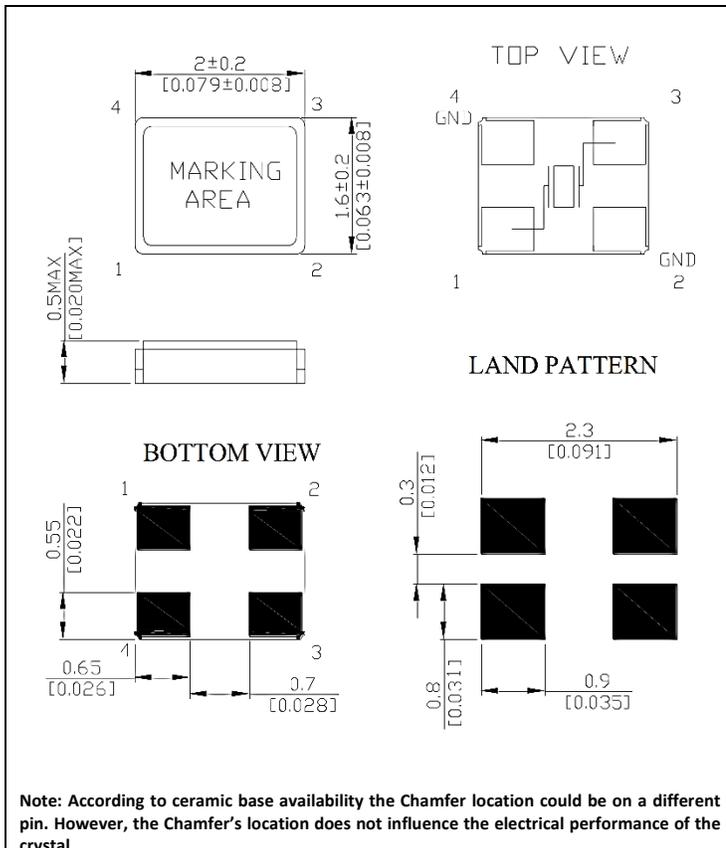
● SPECIFICATIONS

PARAMETER	VALUE
NOMINAL FREQUENCY	27.120 MHz
MODE OF OSCILLATION	Fundamental
FREQUENCY TOLERANCE AT 25°C	±10 ppm max
FREQUENCY STABILITY OVER TEMPERATURE	±10 ppm max
OPERATING TEMPERATURE RANGE	-40°C to +125°C
OPERABLE TEMPERATURE RANGE	-40°C to +100°C
STORAGE TEMPERATURE RANGE	-55°C to +125°C
AGING	±2 ppm first year max
LOAD CAPACITANCE	10 pF
EQUIVALENT SERIES RESISTANCE	100 Ω max
SHUNT CAPACITANCE	3.5 pF max
DRIVE LEVEL	50 μW typ, 200 μw max
INSULATION RESISTANCE	500 MΩ min @ DC 100V

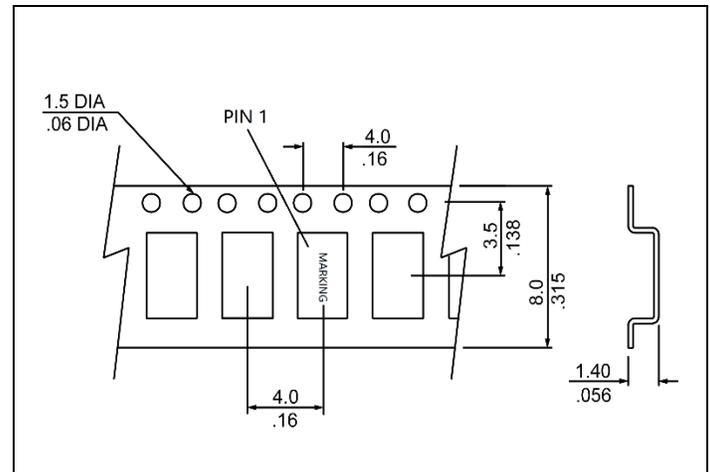


Photo is not actual part

● MECHANICAL SPECIFICATION



● CARRIER TAPE DIMENSIONS



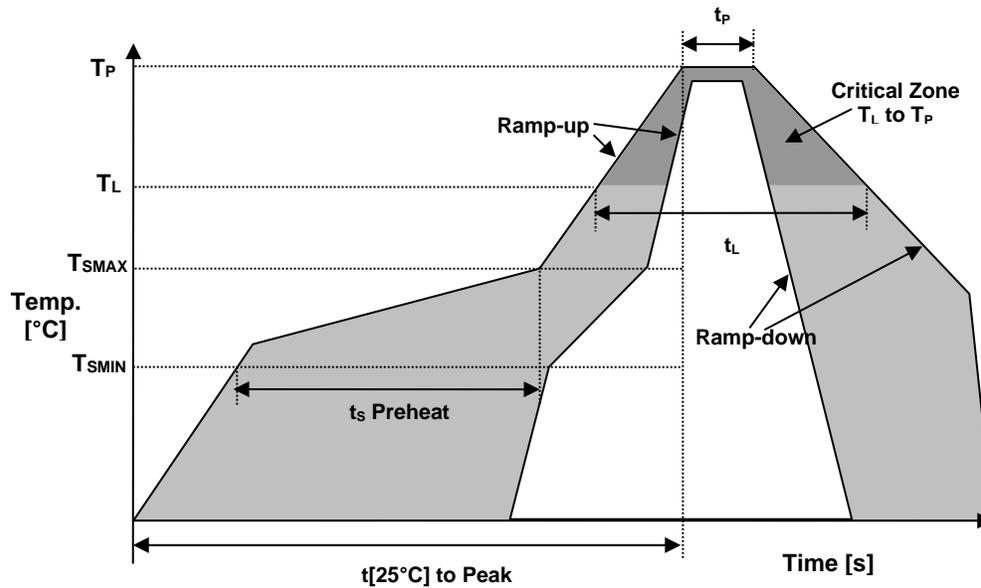
NOTE: REFER TO EIA-481 FOR DIMENSIONS

● PACKAGING

178 mm REEL DIAMETER
8 mm TAPE WIDTH, 4 mm PITCH
QUANTITY: 3000 PIECES PER REEL

IN ACCORDANCE WITH EIA-481

REFLOW PROFILE



Reflow profile		
Temperature Min Preheat	T_{SMIN}	150°C
Temperature Max Preheat	T_{SMAX}	200°C
Time (T_{SMIN} to T_{SMAX})	t_s	60-180 sec
Temperature	T_L	217°C
Peak Temperature	T_P	260°C
Ramp-up rate	R_{UP}	3°C/s max
Ramp-down rate	R_{DOWN}	6°C/s max
Time within 5°C of Peak Temperature	t_p	10 sec
Time $t[25^\circ\text{C}]$ to Peak Temperature	$t[25^\circ\text{C}]$ to Peak	480 sec
Time	t_L	60-150 sec

ENVIRONMENTAL

PARAMETER	VALUE
MOISTURE SENSITIVITY LEVEL	1
RoHS	Compliant
REACH SVHC	Compliant
HALOGEN-FREE	Compliant
ESD CLASSIFICATION LEVEL	N/A
TERMINATION FINISH	Au



● **MARKING**

R27.12
xKEyw

x – 1 or 2 digits as Internal Production ID code
y – Year code
w – Week code

YEAR CODE	
Year	Code
2018	8
2019	9
2020	0
2021	1
2022	2
2023	3
2024	4
2025	5
2026	6
2027	7
2028	8
2029	9

ALPHA WEEK CODE TABLE					
Week	Code	Week	Code	Week	Code
1	a	19	s	37	K
2	b	20	t	38	L
3	c	21	u	39	M
4	d	22	v	40	N
5	e	23	w	41	O
6	f	24	x	42	P
7	g	25	y	43	Q
8	h	26	z	44	R
9	i	27	A	45	S
10	j	28	B	46	T
11	k	29	C	47	U
12	l	30	D	48	V
13	m	31	E	49	W
14	n	32	F	50	X
15	o	33	G	51	Y
16	p	34	H	52	Z
17	q	35	I		
18	r	36	J		

● **APPROVAL**

DRAWN BY:	KJ, March 21, 2024
APPROVED BY:	Jl, March 21, 2024
REVISION:	A, Initial Release

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The process of manufacturing R2016A series of Automotive Grade Surface Mount Microprocessor Crystals is performed by using **Advanced Product Quality Planning (APQP)**. This technique defines and establishes the following actions:

- AEC-Q200 Qualified.
- Product design activities communicating special characteristics to the process design activity, prior to design release, linking the DFMEA to PFMEA.
- Plan, acquire and install appropriate process equipment and tooling based on design tolerances provided by the customer. – CPPD (Collaborative Product Process Design)
- Assembly personnel communicating suggestions on better ways to assemble a product prior to the completion of the design of the product. – DFA/M (Design for Assembly and Manufacturing)
- Manufacturing or Process Engineering establishing adequate Quality Controls for features of a product or parameters of a process, which still risk potential failure. – Control Plan Methodology
- Performing Stability and Capability studies on special characteristics to understand the variation present and predict future performance. – SPC (Statistical Process Control and Process Capability)

Request for **Production Part Approval Process (PPAP)** documentation must be requested at time of order placement. Requests for part approval will be supported in official PPAP format and with documented results as requested at time of order placement. Actual measurements are taken of the parts produced and are used to complete the various test sheets of PPAP.

● **NOTICE**

If you intend to use our product referenced above in an automotive application that may result in loss of life or assets, please do not fail to advise us of your intention beforehand. The use of the listed part in those applications is not covered by warranty, and we will not be held accountable for any liability claims. We reserve the right to not supply parts in those circumstances.